

#### RoHS Po

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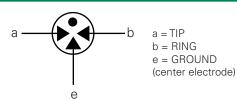




#### **Agency Approvals**

AGENCY	AGENCY FILE NUMBER
<i>L</i> R <sub>®</sub>	E128662

#### 3 Electrode GDT Graphical Symbol



#### **Features**

- RoHS compliant
- · Low insertion loss
- Excellent response to fast rising transients
- Ultra low capacitance
- 10KA (A suffix devices) / 20KA (B suffix devices) surge capability tested with 8/20µs pulse as defined by IEC 61000-4-5
- Available with thermal failsafe option (add 'F' suffix to part number)

#### **Applications**

#### SL1021 / SL1024:

- Broadband equipment
- ADSL equipment
- XDSL equipment
- Satellite and CATV equipment
- Splitters
- General telecom equipment

#### PMT8:

- Telecom network interfaces
- Telephone line cards
- Repeaters
- Modems
- Line test equipment

#### **Description**

GDT circuit protection devices dissipate electrical surge energy safely within a contained plasma gas. Commonly used to help protect sensitive telecom and networking equipment and lines, GDTs protect from damage that may result from lightning strikes and equipment switching operations.

The Littelfuse GDT series described in this document are available in a variety of leaded and surface mount forms and offered with and without optional failsafe clip. Please refer to the electrical specifications, dimension and packaging options section of this document for additional information.

#### SL1021A/B and SL1024A/B Series:

SL1021A/B and SL1024A/B series GDTs are designed to offer high levels of performance on fast rising transients in the range of 100V/µS to 1KV/µS, which are those most likely created by induced lightning disturbances.

These devices feature ultra low capacitance (typically 1.5pF or less) and are extremely robust with SL102xA devices able to divert a 10,000 Amp pulse without destruction, and SL102xB suffix devices able to divert a 20,000 Amp pulse without destruction.

These series offer optimized internal geometry which provide low insertion loss at high frequencies, ideal for the protection of broadband and other high speed transmission equipment.

#### **PMT8 Series:**

PMT8 GDT's are telecom grade devices designed to meet the recommendations in CCITT-K12 and Bellcore GR-1361-CORE. The three electrode configuration is used in applications where simultaneous crowbar action of two signal lines is required.

#### **Product Characteristics**

Materials	Dull Tin Plate 17.5 ± 12.5 Microns. with ceramic insulator		
Product Marking	'LF' mark, voltage& date code: SL102x <b>A - Red</b> /White text SL102x <b>B &amp; PMT8 - Blue</b> /White text		
Glow to arc transition current	~ 1Amp		
Glow Voltage	~60-200 Volts		
Storage and Operation Temperature	-40 to +90°C		
Transverse Voltage (Delay Time)	< 0.2μSec (Tested to ITU-T Rec. K.12)		
Arc Voltage	~10 to 35 Volts		
Holdover Voltage	<150mS (Tested to ITU-T Rec. K.12)		

## Gas Discharge Tube (GDT) Products SL1021A/B, SL1024A/B and PMT8 Series



#### **Electrical Characteristics**

Device Specifications (at 25°C)						Life Ratings													
Part Number*		C Volta 00V/Se TYP		DC Voltage 100 V/ µSec.	DC Voltage 1kV/ µSec.	Capaci- tance (@1Mhz)	Insulation Resistance MIN	AC Current 50Hz	Surge Current 8/20µSec	Max Single Surge	Max Single Surge 10/350µSec¹	Surge Life 10/1000 µSecx3001							
SL1021A090 SL1024A090 SL1021B090 SL1024B090 PMT 8 090	72	90	108	µэес.	650		>10 <sup>10</sup> Ω (at 50V)	>10 <sup>10</sup> Ω	1Sec.x10' x10'	8/20µSec¹	4kA² 5kA³								
SL1021A145 SL1024A145 SL1021B145 SL1024B145	116	145	174	500															
SL1021A150 SL1024A150 SL1021B150 SL1024B150	120	150	180		600	600													
SL1021A200	150	200	250																
SL1021A230 SL1024A230 SL1021B230 SL1024B230 PMT 8 230	184	230	276	450	050														
SL1021A250 SL1024A250 SL1021B250 SL1024B250 PMT 8 250	200	250	300	500	650	- <1.5pF >10 <sup>10</sup> Ω (at 100V)		404	10kA²	15kA²		200Amps							
SL1021A260 SL1024A260 SL1021B260 SL1024B260	210	260	310	550	700														
SL1021A300 SL1024A300 SL1021B300 SL1024B300	240	300	360	650	850		<1.5pF	< 1.5pr		10Amps	20kA <sup>3</sup>	25kA <sup>3</sup>	2.5kA² 5kA³	Zouamps					
SL1021A350 SL1024A350 SL1021B350 SL1024B350 PMT 8 350	280	350	420	700	900														
SL1021A400 SL1024A400 SL1021B400 SL1024B400 PMT 8 400	320	400	480	850	950	950							)						
SL1021A420 SL1024A420 SL1021B420 SL1024B420	345	420	500																
SL1021A450 SL1024A450 SL1021B450 SL1024B450	360	450	540	900	1000														
SL1021A500 SL1024A500 SL1021B500 SL1024B500	400	500	600	950	1100														
SL1021A600 SL1024A600	480	600	720	1000	1200														

#### NOTES:

<sup>\*</sup>Max capacitance is 1.5 pF, measured at 1 MHz.

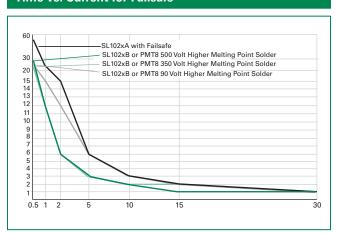
Total current through centre electrode, tested in accordance with ITU-T Rec K.12

<sup>2.</sup> SL A series

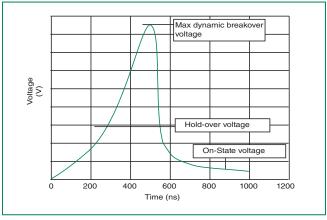
<sup>3.</sup> SL B series & PMT 8 series

### **Gas Discharge Tube (GDT) Products** SL1021A/B, SL1024A/B and PMT8 Series

#### Time vs. Current for Failsafe

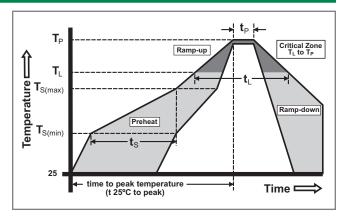


# Voltage vs. Time Characteristic Max dynamic breakover voltage



#### **Soldering Parameters - Reflow Soldering (Surface Mount Devices)**

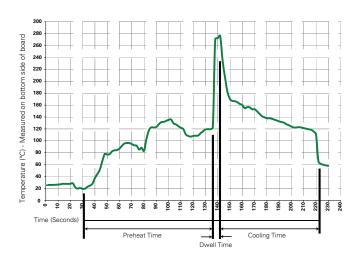
Reflow Co	ondition	Pb – Free assembly	
	-Temperature Min (T <sub>s(min)</sub> )	150°C	
Pre Heat	-Temperature Max (T <sub>s(max)</sub> )	200°C	
	-Time (Min to Max) (t <sub>s</sub> )	60 – 180 secs	
Average r	amp up rate (Liquidus Temp ık	3°C/second max	
T <sub>S(max)</sub> to T <sub>I</sub>	- Ramp-up Rate	5°C/second max	
D (1	-Temperature (T <sub>L</sub> ) (Liquidus)	217°C	
Reflow	-Temperature (t <sub>L</sub> )	60 – 150 seconds	
PeakTemp	perature (T <sub>P</sub> )	260 <sup>+0/-5</sup> °C	
Time with	in 5°C of actual peak ure (t <sub>p</sub> )	10 - 30 seconds	
Ramp-dov	vn Rate	6°C/second max	
Time 25°C	to peakTemperature (T <sub>P</sub> )	8 minutes Max.	
Do not ex	ceed	260°C	



#### **Soldering Parameters - Hand Soldering**

Solder Iron Temperature: 350° C +/- 5°C Heating Time: 5 seconds max.

#### Soldering Parameters - Wave Soldering (Thru-Hole Devices)



#### **Recommended Process Parameters:**

Wave Parameter	Lead-Free Recommendation		
Preheat: (Depends on Flux Activation Temperature)	(Typical Industry Recommendation)		
Temperature Minimum:	100° C		
Temperature Maximum:	150° C		
Preheat Time:	60-180 seconds		
Solder Pot Temperature:	280° C Maximum		
Solder DwellTime:	2-5 seconds		

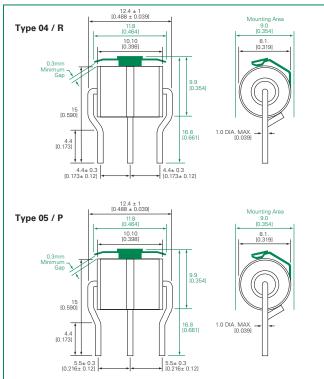
Note: Surge Arrestors with a Failsafe mechanism should be individually examined after soldering



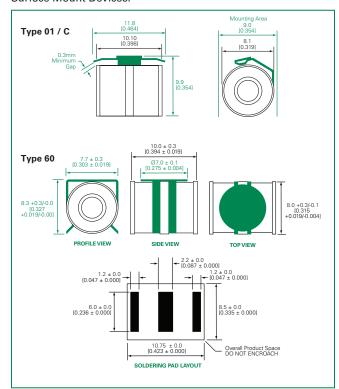
#### **Device Dimensions**

NOTE: Failsafe option dimensions shown in green.

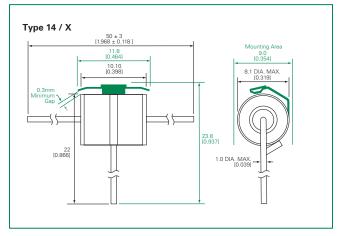
#### Shaped Radial Leaded Devices:



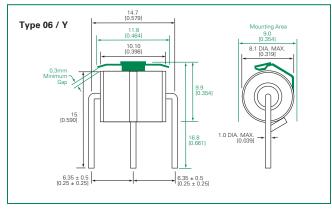
#### Surface Mount Devices:



#### Straight "T" Leaded Devices:

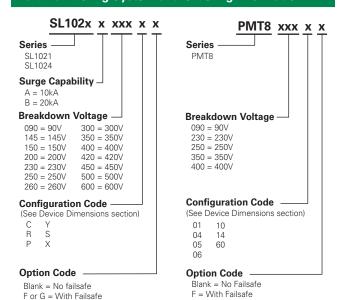


#### Straight Radial Leaded Devices:



## Gas Discharge Tube (GDT) Products SL1021A/B, SL1024A/B and PMT8 Series

#### **Part Numbering System and Ordering Information**



#### **Packaging**

Device Type	Description	Quantity
Type 01 / C	100pcs/tray x 5 trays per carton	500
Type 04 / R	100pcs/tray x 5 trays per carton	500
Type 05 / P	100pcs/tray x 5 trays per carton	500
Type 06 / Y	100pcs/tray x 5 trays per carton	500
Type 14 / X	50pcs/tray x 5 trays per carton	250
Type 60	500pcs/reel* x 10 reels per carton	5000

<sup>\*</sup> For tape and reel specifications, please contact factory.